



# **FCC Conductor Challenges FCC Week 2015**

**A. Ballarino, CERN**

**Washington, 25/03/2015**

**A. Ballarino, B. Bordini, L. Bottura**

# Outline

- State of art performance of Nb<sub>3</sub>Sn wire for LHC Hi-Lumi upgrade
- Nb<sub>3</sub>Sn conductor for FCC
  - Targets for R&D development
  - Challenges
- Conclusions

# Nb<sub>3</sub>Sn Conductor for Hi-Lumi LHC

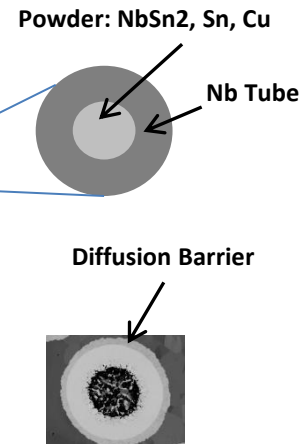
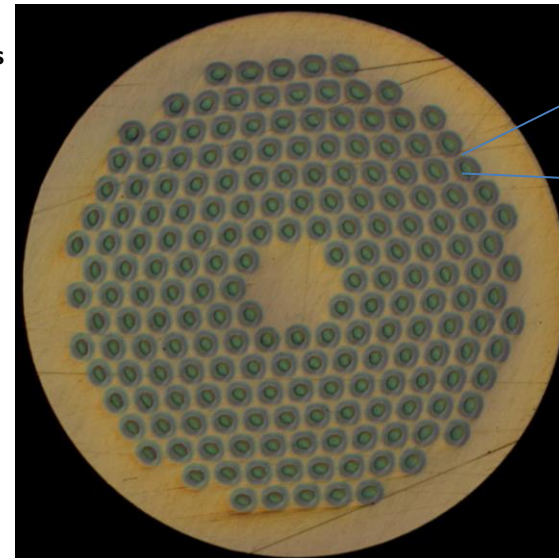
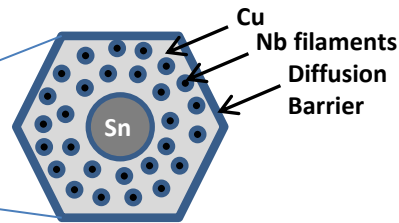
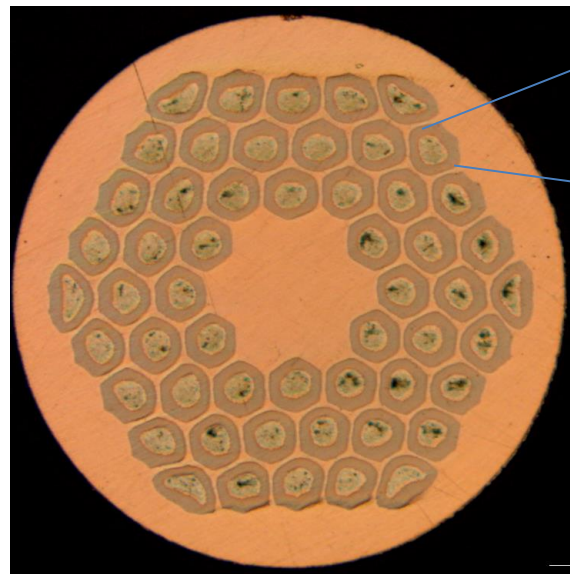
- Fresca 2 - 13 T @ 1.9 K, block-coils Nb<sub>3</sub>Sn dipole (to be used in the Superconducting Cables Test Station at CERN)
- 11 T Dipoles – Accelerator magnets for Hi-Lumi LHC, Nb<sub>3</sub>Sn 11 m long  $\cos\theta$  dipoles (upgrade of LHC collimation system)
- Triplet Quadrupoles – Accelerator magnets for HL-LHC, Nb<sub>3</sub>Sn  $\cos\theta$  Inner Triplet LHC quadrupoles (**CERN and USA LARP Program**)

Hi-Lumi LHC magnets : integration in LHC in 2018 and in 2023.  
Procurement of wire for magnet series production started

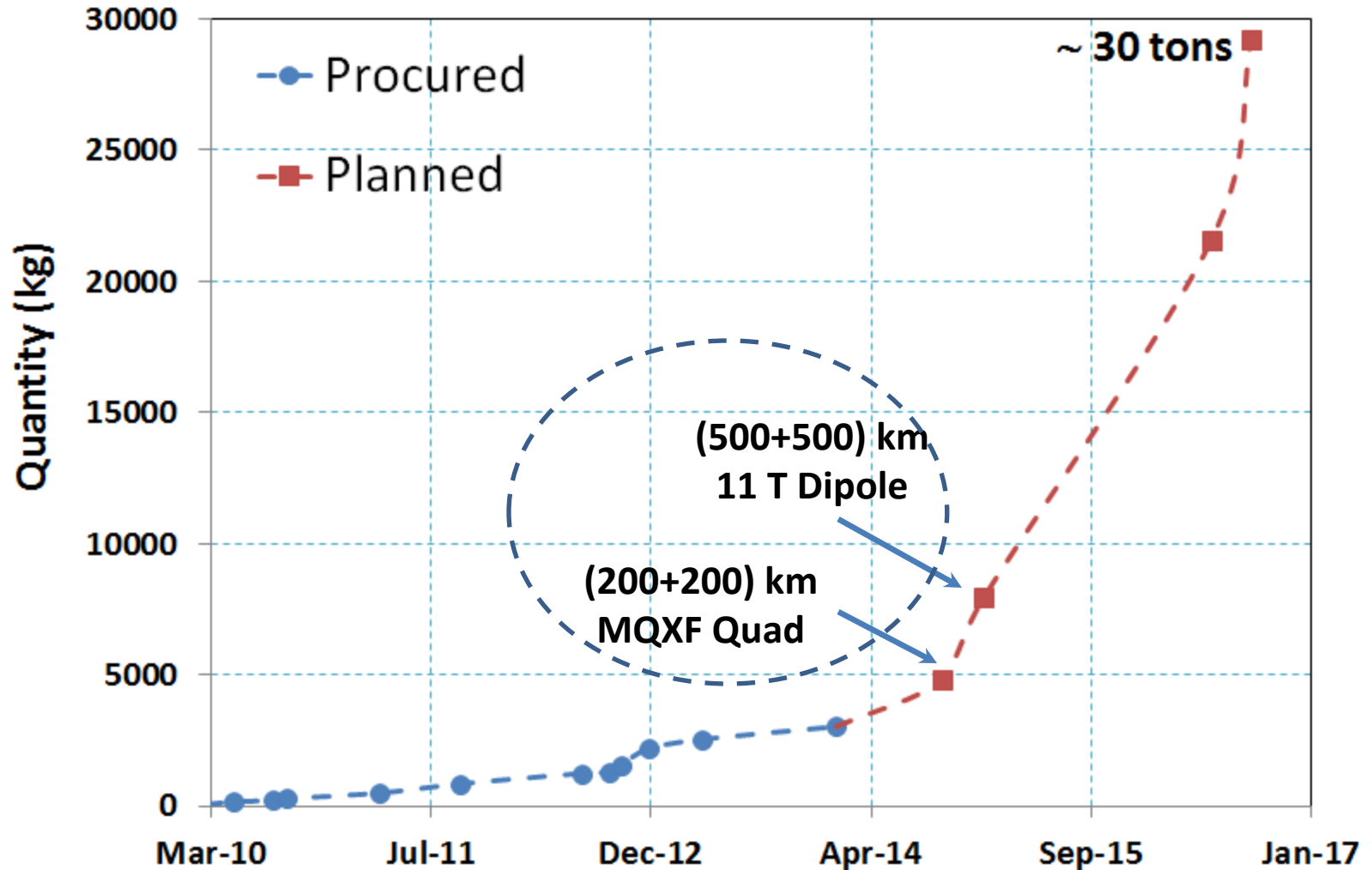
# Nb<sub>3</sub>Sn Conductor for Hi-Lumi LHC

- Internal Sn (RRP<sup>®</sup>, OST)
- Powder in Tube (PIT, Bruker EAS)

Both technologies are based on solid state diffusion to transport Sn from the source to the Nb and both require a diffusion barrier



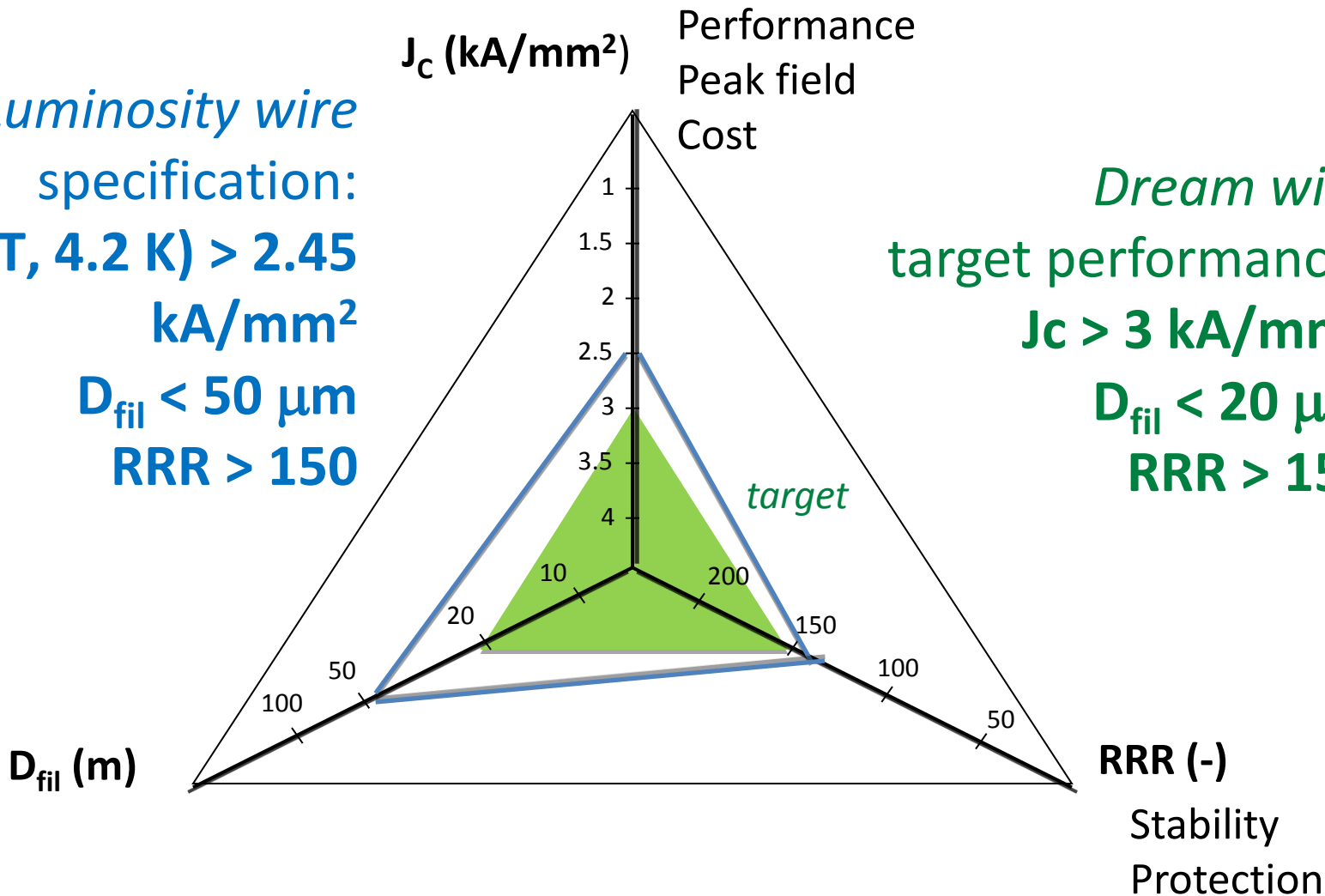
# Nb<sub>3</sub>Sn Conductor for Hi-Lumi



# Nb<sub>3</sub>Sn specification for Hi-Lumi LHC

*Hi-Luminosity wire*  
specification:  
 **$J_c(12T, 4.2 K) > 2.45$**   
 **$kA/mm^2$**   
 **$D_{fil} < 50 \mu m$**   
 **$RRR > 150$**

*Dream wire*  
target performance:  
 **$J_c > 3 kA/mm^2$**   
 **$D_{fil} < 20 \mu m$**   
 **$RRR > 150$**

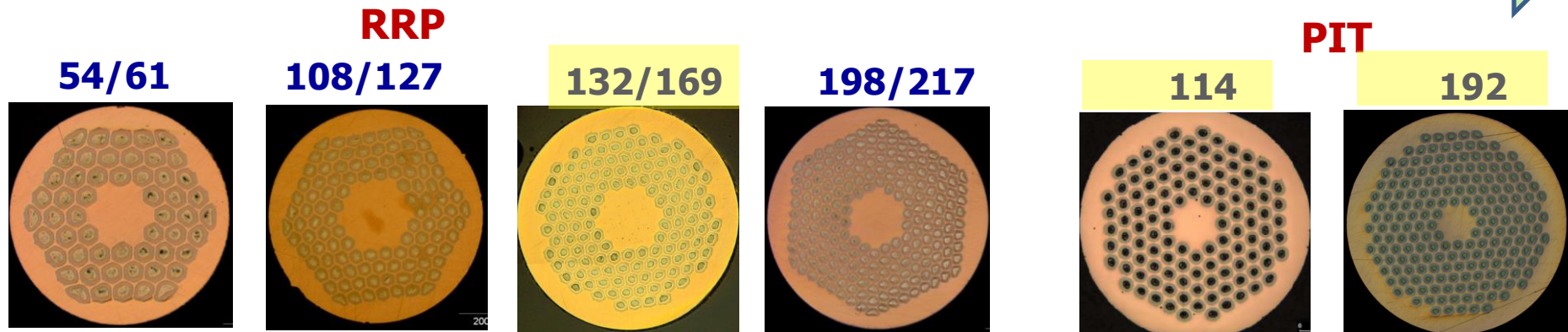


**+ Mechanical properties**

# Conductor procured BY CERN for Hi-Lumi LHC

	Sub-element size ( $\mu\text{m}$ )					
	Wire $\Phi$ (mm)	RRP® 108/127	RRP® 132/169	RRP® 192/217	PIT 114	PIT 192
<b>FRESCA 2*</b>	<b>1</b>	-	58	-	-	48
<b>Hi-Lumi Quad</b>	<b>0.85</b>	-	48	-	-	41
<b>11 T</b>	<b>0.7</b>	46	41	32	44	-

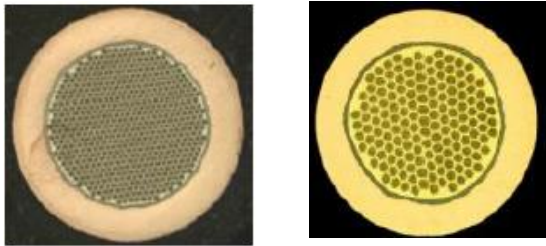
Smaller sub-element size



\*Fresca 2 conductor: procurement by CERN and CEA – FP7 European Project

# Conductor specification for Hi-Lumi LHC

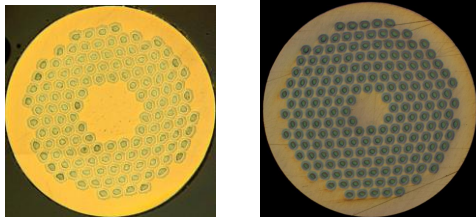
ITER strand: Non-Cu  $J_c \geq 800 \text{ A/mm}^2$  (12 T, 4.2 K)



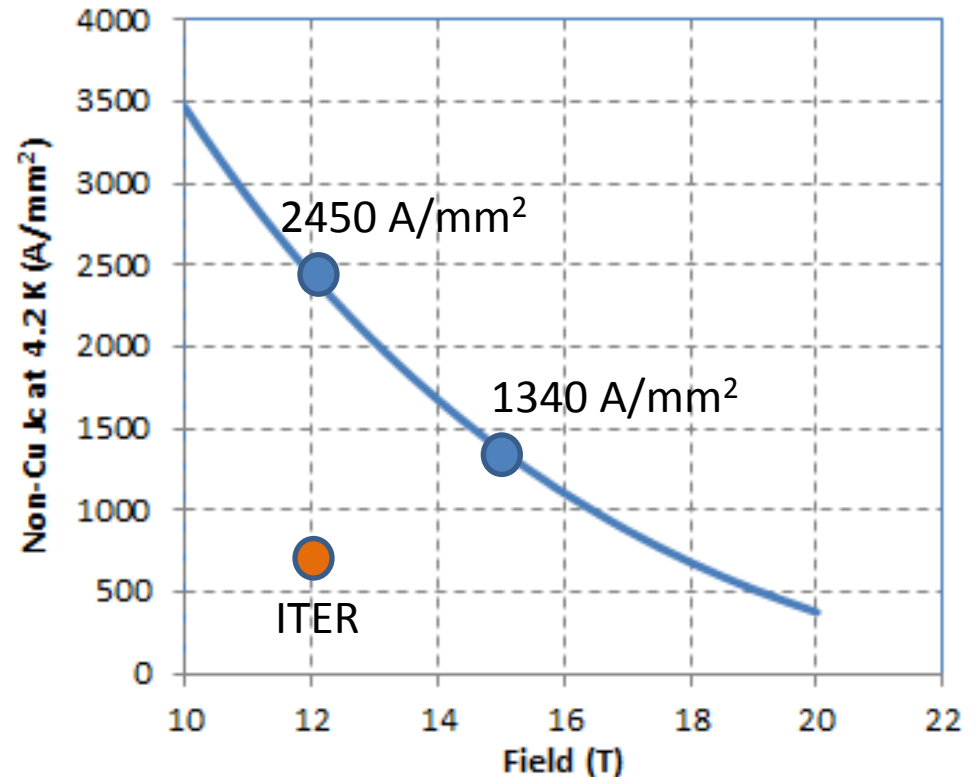
Hi-Lumi strand: Non-Cu  $J_c \geq 2500 \text{ A/mm}^2$  (12 T, 4.2 K)

RRP 132/169

PIT 192

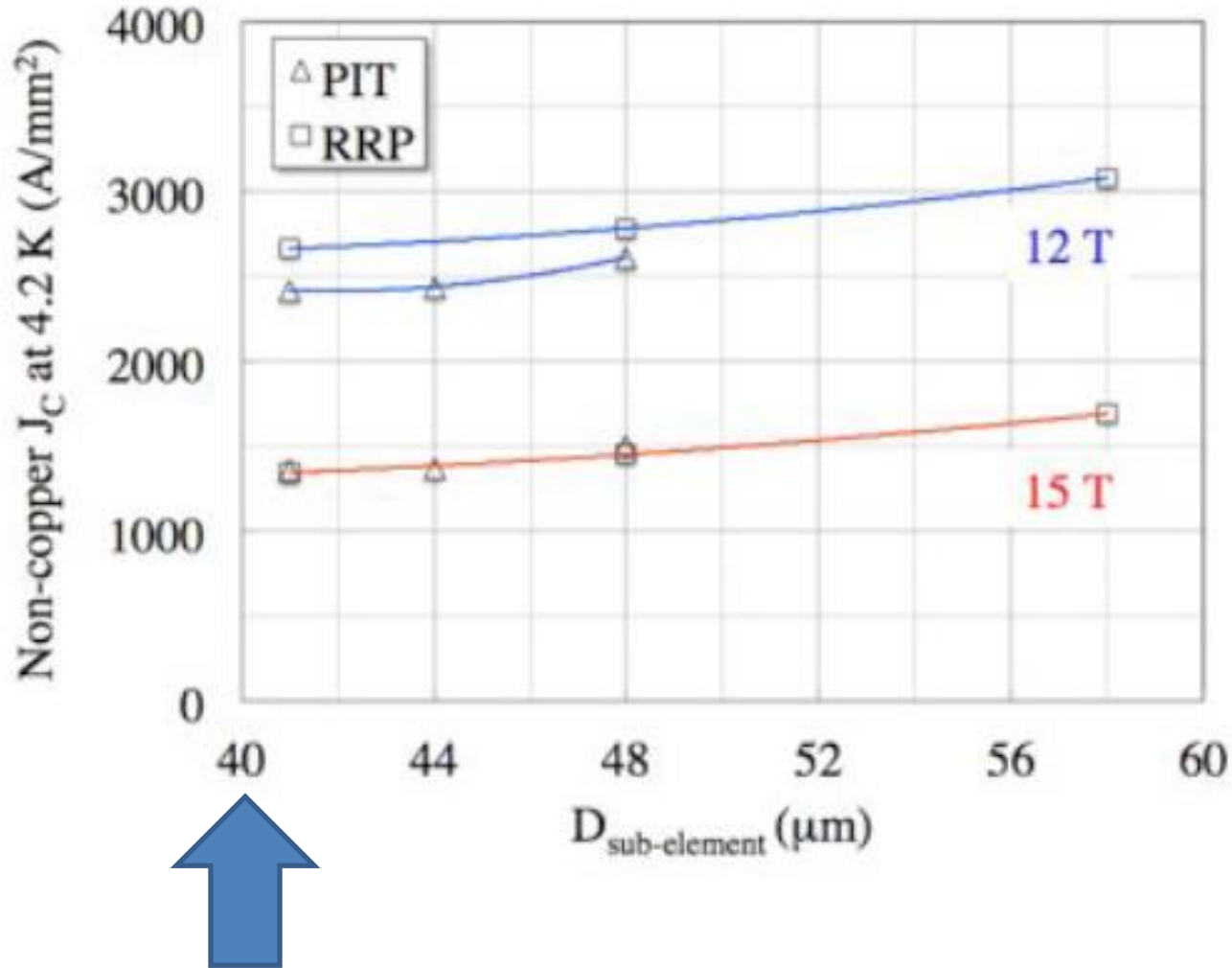


Critical current density versus field





# Jc vs filament diameter



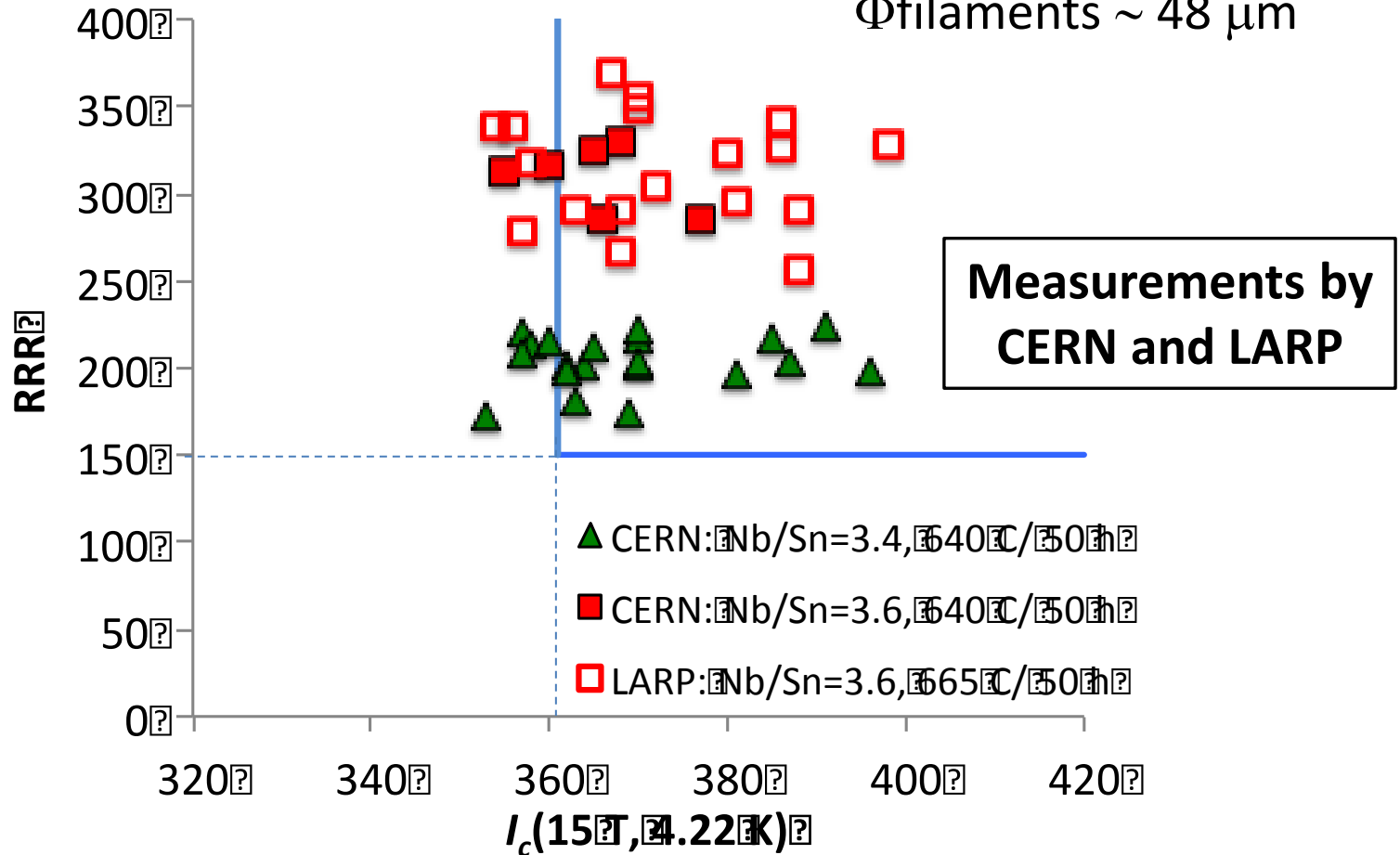
Measurements @ CERN

# Inner Triplets Quadrupole wire – Jc vs RRR

Maintain performance during large production

$\Phi_{\text{wire}} = 0.85 \text{ mm}$

$\Phi_{\text{filaments}} \sim 48 \mu\text{m}$



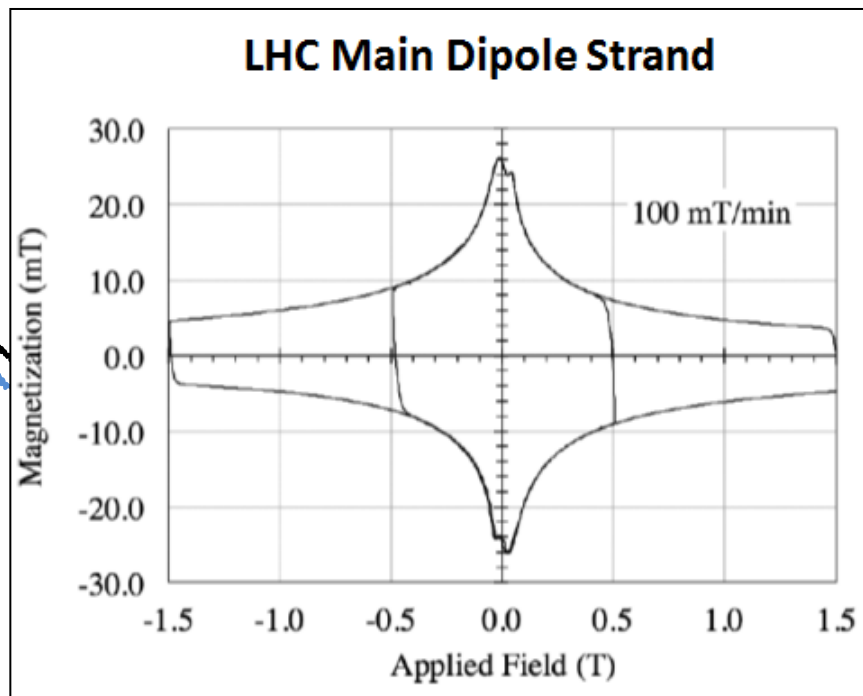
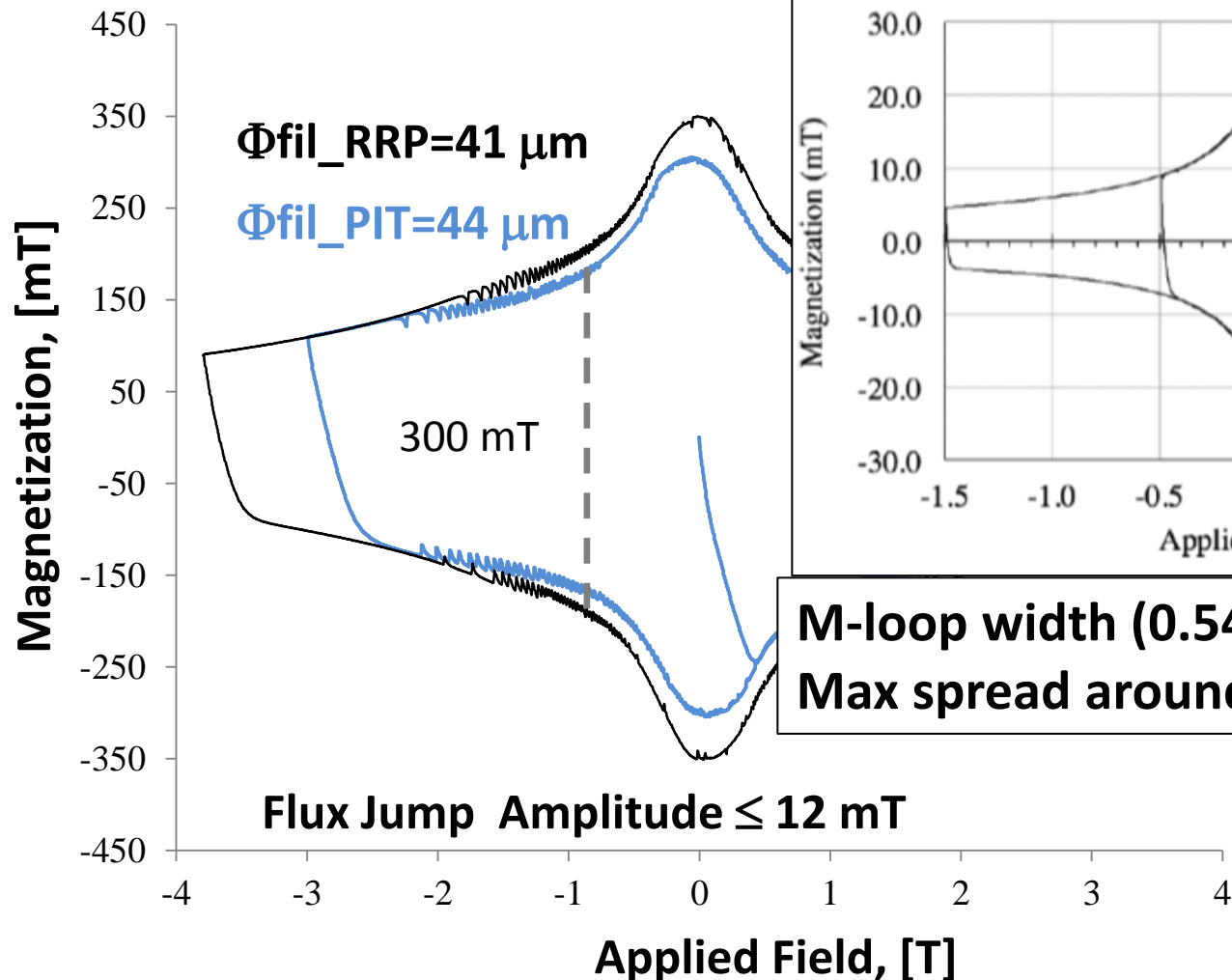
$$I_c(15 \text{ T}, 4.22 \text{ K}) = 361 \text{ A} \rightarrow J_c(15 \text{ T}, 4.2 \text{ K}) = 1350 \text{ A/mm}^2$$

# Magnetization measurements - Hi-Lumi Nb<sub>3</sub>Sn wires

Reduce filaments size to reduce magnetization

T = 1.9 K

$\Phi = 0.7$  mm (11 T dipole)



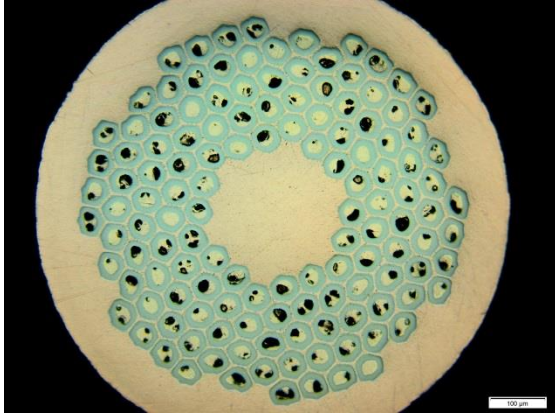
M-loop width (0.54 T, 1.9 K) < 30 mT  
Max spread around average  $\pm 4.5$  %

Measurements @ CERN

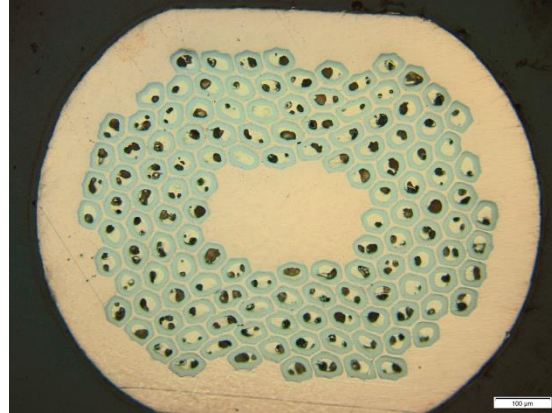
# Effect of mechanical deformation

## Rolled Wire

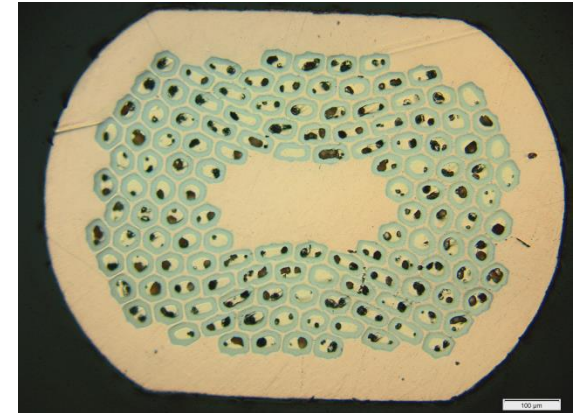
Round Wire



Rolled 15%



Rolled 20%



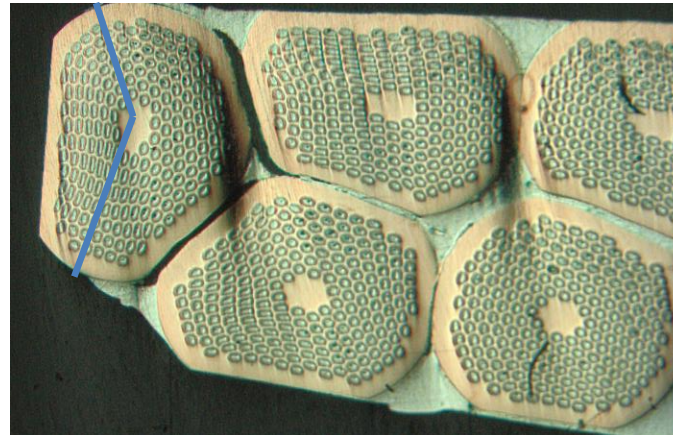
## Rutherford Cable

Thin edge



Packing factor ~ 86 %

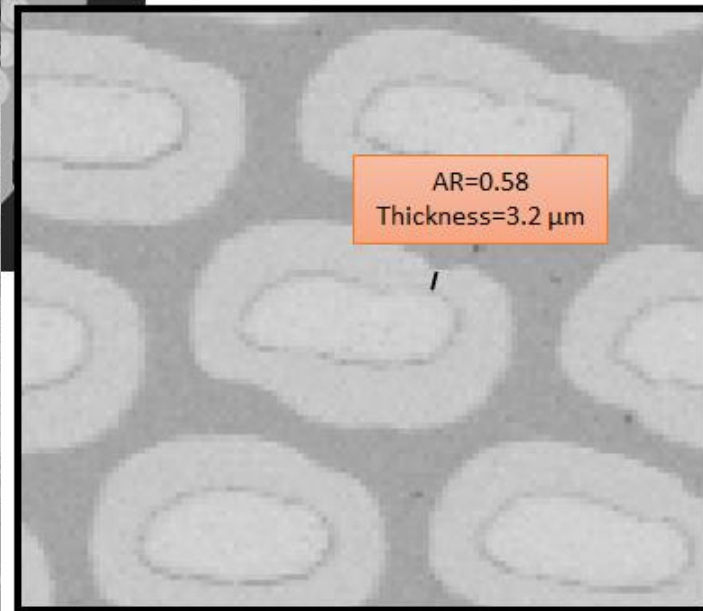
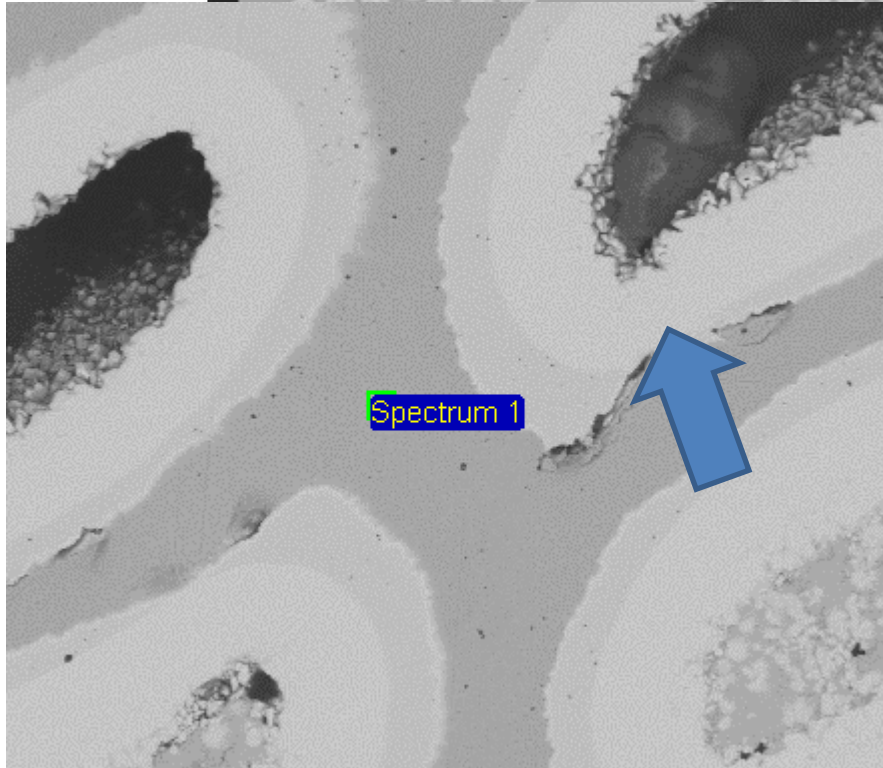
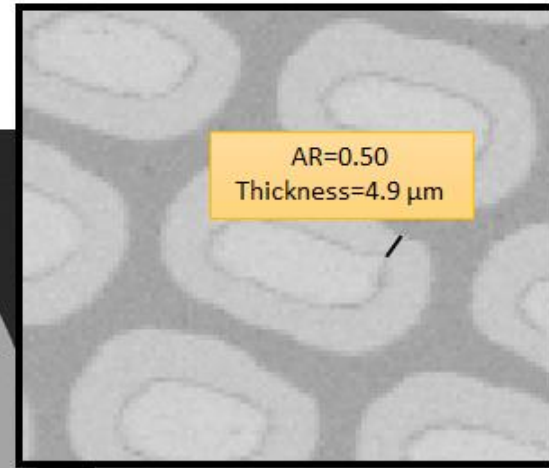
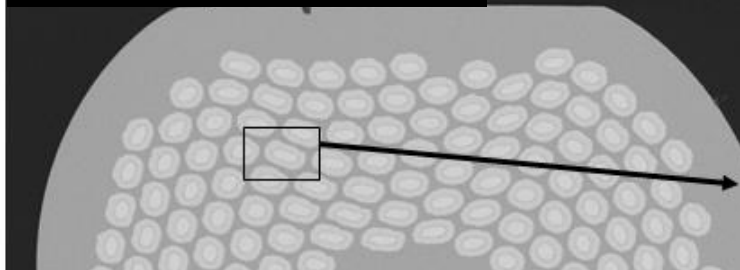
Assure mechanical properties of wires - as required for cabling



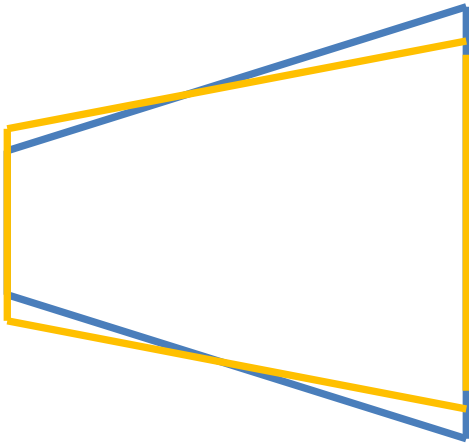
Cabling:  
Ic degradation < 5 %  
RRR > 100

# Required homogeneous mechanical deformation

20 % Rolling test



# Nb<sub>3</sub>Sn cable for Inner Triplet Quadrupoles



<b>Width</b>	mm	18.15	18.15
<b>Keystone</b>	deg	0.55	0.4
<b>Thin Edge</b>	mm	1.438	1.462
<b>Thick Edge</b>	mm	1.612	1.588
<b>Mid Thickness</b>	mm	1.525	1.525
<b><math>\epsilon</math>_Thin Edge</b>	%	15.4	14
<b>Packing factor</b>	%	86	86.5

— Cable 1st iteration

— Cable 2nd iteration

Try to cope with mechanical properties of wires

Ic cabling degradation achieved: < 3 %

# Outline

- State of art performance of Nb<sub>3</sub>Sn wire for LHC Hi-Lumi upgrade
- Nb<sub>3</sub>Sn conductor for FCC
  - Targets for R&D development
  - Challenges
- Conclusions

# Targets for Nb<sub>3</sub>Sn conductor R&D

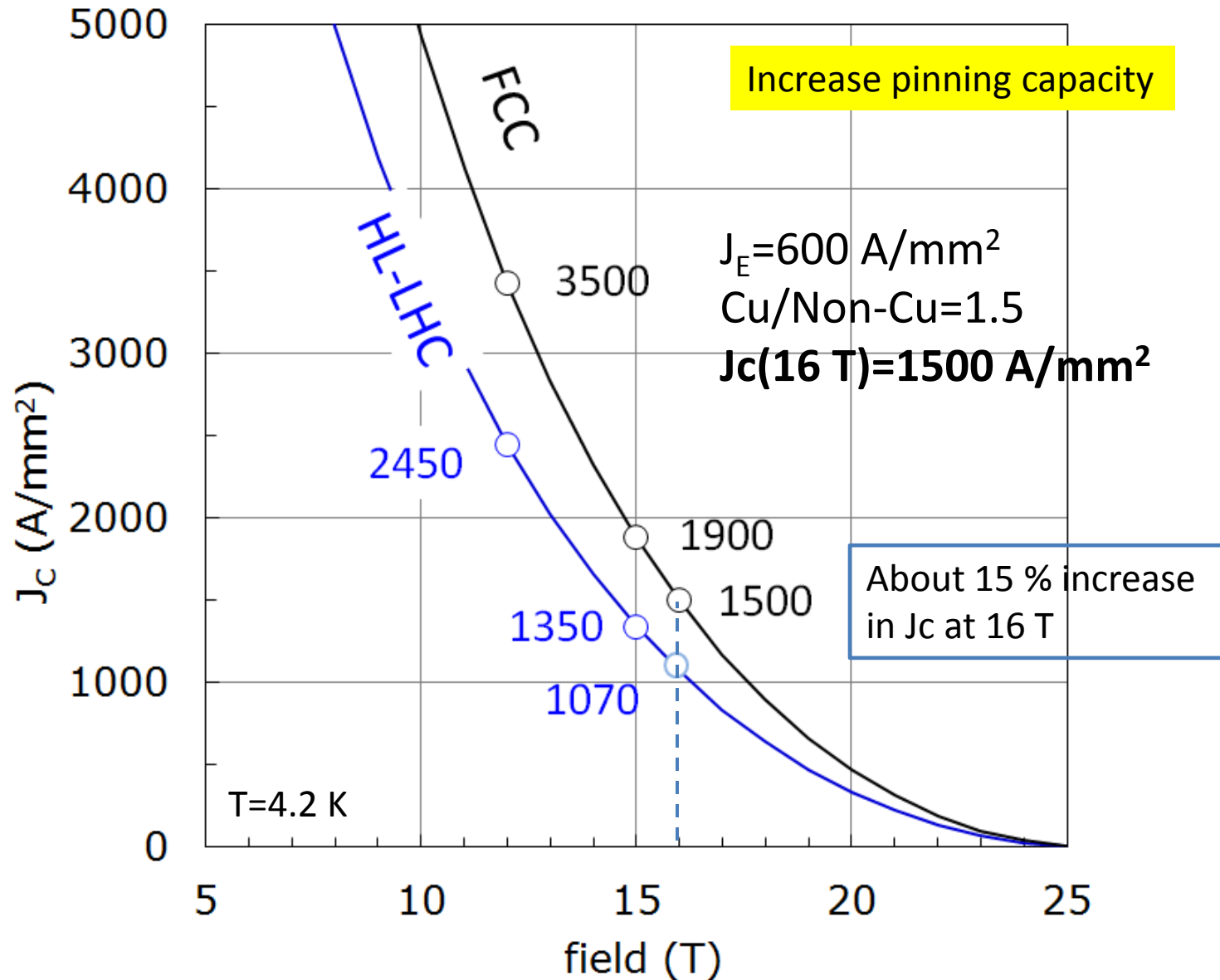
---

<b>Wire diameter</b>	mm	<b>≤ 1</b>
<b>Non-Cu J<sub>c</sub> (16 T, 4.2 K)</b>	<b>A/mm<sup>2</sup></b>	<b>≥ 1500</b>
<b>μ<sub>0</sub>ΔM(1 T, 4.2 K)</b>	mT	<b>≤ 150</b>
<b>σ(μ<sub>0</sub>ΔM) (1 T, 4.2 K)</b>	%	<b>≤ 4.5</b>
<b>D<sub>eff</sub></b>	<b>μm</b>	<b>≤ 20</b>
<b>RRR</b>	-	<b>≥ 150</b>
<b>Unit length</b>	km	<b>≥ 5</b>

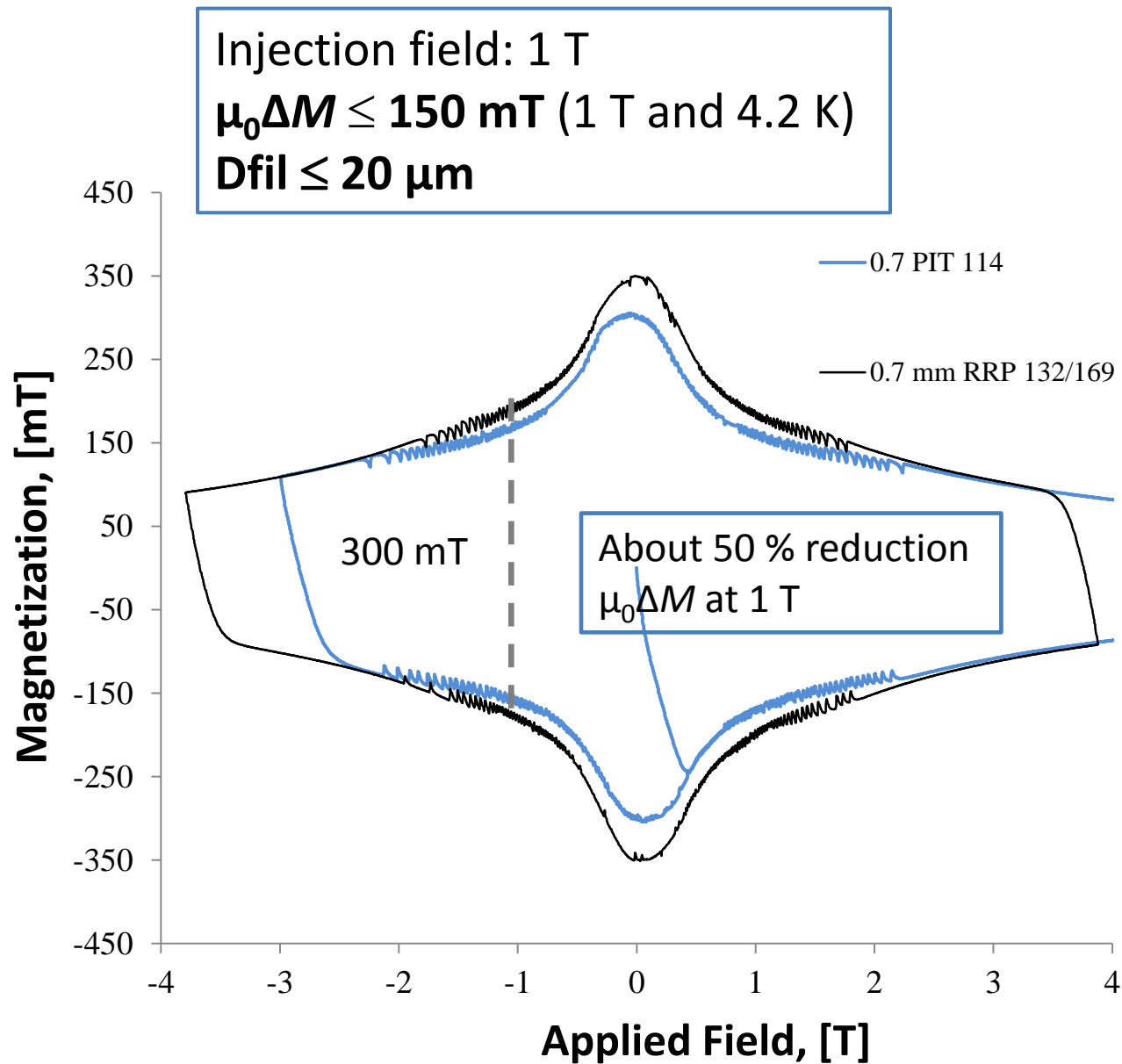
---



# Target for Nb<sub>3</sub>Sn conductor R&D (J<sub>c</sub>)



# Target for Nb<sub>3</sub>Sn conductor R&D (Dfil)

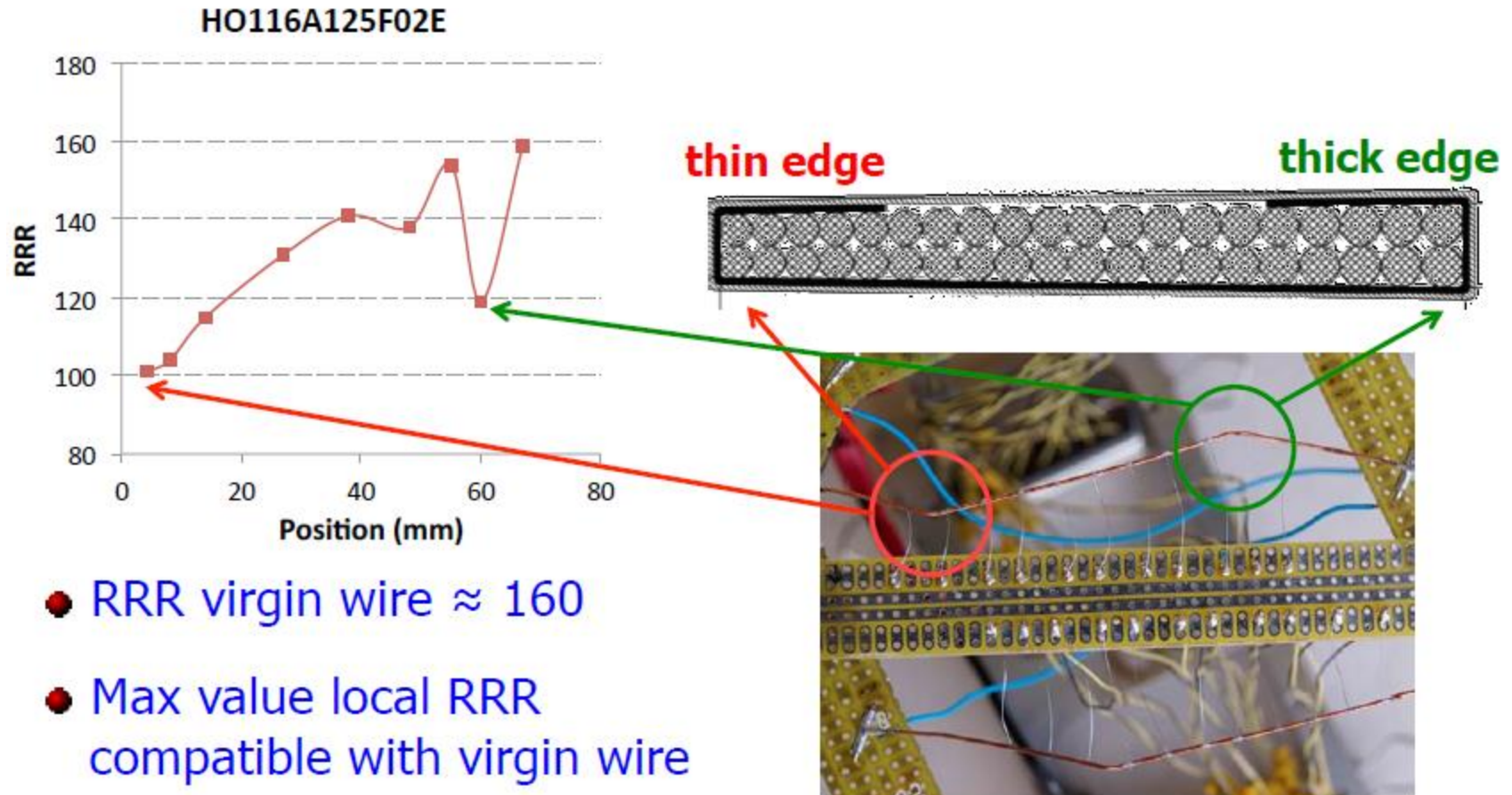


# Target for Nb<sub>3</sub>Sn conductor RRR (RRR)

- The stabilizing effect of high Cu RRR in a wire saturates at values of about 100
- During cabling, filaments are distorted and local RRR decreases – Sn diffusion in the Cu matrix
- **RRR ≥ 150 in round wire** in order to assure a local RRR ≥ 100 in strands

# Target for Nb<sub>3</sub>Sn conductor R&D (RRR)

## Local RRR on extracted strands



# Target for Nb<sub>3</sub>Sn conductor R&D (Cost)

FCC-hh, 100 km, 16 T, 100 TeV (c.o.m.) : ~ **6000 tons Nb<sub>3</sub>Sn**  
(and 3000 tons Nb-Ti) – to be compared with 1265 tons of  
Nb-Ti in LHC

**Wire architecture** must be designed to *scale* with high yield  
and commercial volumes

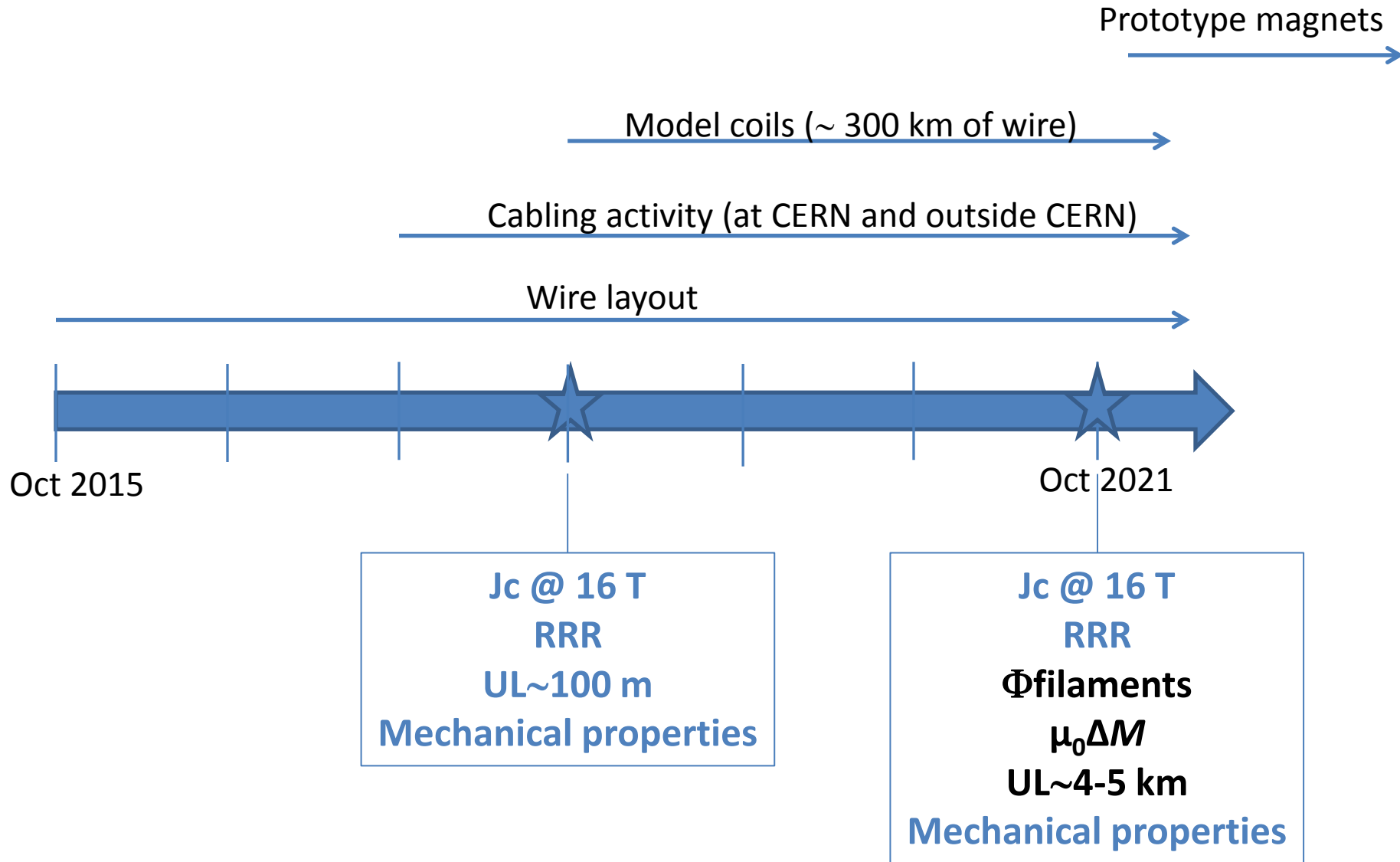
Required:

Improvement of performance with respect to state of the  
art wire;

Scaling up of billet-size and yield for series production

**Target cost:** 5 Euro/kA at 4.2 K and 16 T

# Timeframe for Nb<sub>3</sub>Sn conductor R&D



**Six years of R&D program**

# Characterization of Nb<sub>3</sub>Sn conductor for FCC

- **Material studies** (optical, FIB, SEM, TEM, EDS,...)
- Test facilities for **I<sub>c</sub> measurements of Nb<sub>3</sub>Sn wires** at LHe temperature and at 16 T and above (16 T-18 T)
- Test facilities for **magnetization measurements of Nb<sub>3</sub>Sn wires** at liquid helium temperature and at 16 T and above (16 T-18 T)
- Test facilities for Nb<sub>3</sub>Sn **cable characterization**

# Not to forget

➤ The Future Circular Collider will require other superconducting devices. Besides special (HTS) magnets, also:

➤ **HTS Current Leads (BSCCO 2223 or REBCO based);**

➤ **Superconducting Links ( $\text{MgB}_2$  or HTS based)**

for feeding the magnet electrical circuits



# Conclusions (1/2)

- **R&D** Program on Nb<sub>3</sub>Sn conductor is **required** for achieving FCC performance targets. Simple extrapolation and improvement of existing strand architectures will not be sufficient – a quantum improvement in performance and an evolutionary change in technology is required
- Conductor development shall start well ahead of magnet development. Required **work with conductor manufacturers** to ensure that the developed wires meet performance/characteristics for accelerator quality magnets - and are of a sufficiently robust quality for large scale production

# Conclusions (2/2)

- A very large quantity of Nb<sub>3</sub>Sn conductor would be required, well above present production capability
- Conductor development shall start well ahead of magnet development
- Not to forget:

A magnet cannot perform better than the conductor it is made of

***Thanks for your attention***